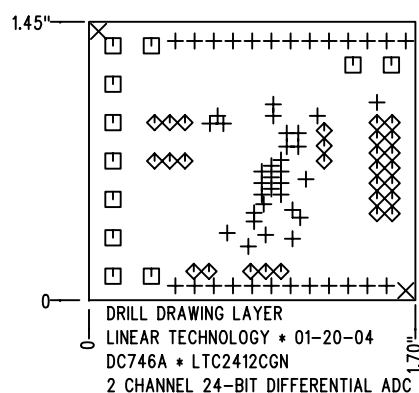


REVISIONS			
REV	DESCRIPTION	APPR	DATE
A	PROTOTYPE RELEASE		

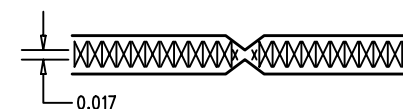


SHOWN FROM COMPONENT SIDE


SIZE	QTY	SYM	PLTD
0.015	56	+	PLTD
0.07	2	×	NPLTD
0.064	11	□	PLTD
0.035	28	◇	PLTD

#### NOTES : Unless Otherwise Specified

1. MATERIAL : FR4 OR EQUIVALENT EPOXY, 2 OZ. COPPER CLAD  
THICKNESS .062 +/- .006 TOTAL OF 4 LAYERS.
2. FINISH : ALL PLATED HOLES .001 MIN. / .0015 MAX. COPPER PLATE  
ELECTRODEPOSITED TIN-LEAD COMPOSITION  
BEFORE REFLOW , SOLDER MASK OVER BARE COPPER (SMOBC).
3. SOLDER MASK : BOTH SIDES USING LPI OR EQUIVALENT.
4. SILKSCREEN : USING WHITE NON-CONDUCTIVE EPOXY INK.
5. UNUSED SMD COMPONENTS SHOULD BE FREE OF SOLDER.
6. SCORING:



7. PLEASE LOOK AT THE README FILE FOR THE OTHER REQUIREMENTS.

APPROVALS			 1630 MCCATHY BLVD MILPITAS, CA 95035 PH: (408)432-1900 LTC CONFIDENTIAL- FOR CUSTOMER USE ONLY	
DRAWN	INIT	DATE		
CHECK			TITLE: FABRICATION DRAWING 2 CHANNEL 24-BIT DIFFERENTIAL ADC	
DESIGN	KIM T.	01-20-04		
ENGR	MARK T.	01-20-04	SIZE A DEMO DC746A-LTC2412CGN REV. A	
SCALE = NONE			DES- 0000	SHT 1 of 1